

N-channel 600 V, 0.55 Ω typ., 7.5 A MDmesh[™] M2 Power MOSFET in a TO-220FP package

Datasheet - production data

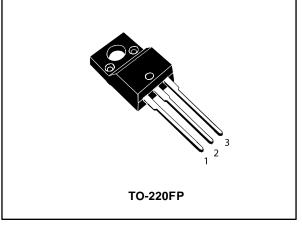
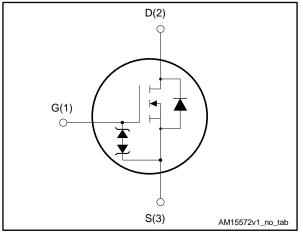


Figure 1: Internal schematic diagram



Features

Order code	VDS@TJmax.	RDS(on) max.	ID
STF10N60M2	650 V	0.60 Ω	7.5 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This device is an N-channel Power MOSFET developed using MDmesh[™] M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STF10N60M2	10N60M2	TO-220FP	Tube

DocID024712 Rev 4

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
له ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C	7.5	^
ID(**	Drain current (continuous) at T _{case} = 100 °C	4.9	A
IDM ⁽²⁾	Drain current (pulsed)	30	А
P _{TOT}	Total dissipation at T _{case} = 25 °C	25	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽⁴⁾	MOSFET dv/dt ruggedness	50	v/ns
Viso ⁽⁵⁾	Insulation withstand voltage (RMS) from all three leads to external heat sink	2500	V
T _{stg}	Storage temperature range	55 to 150	°C
Tj	Operating junction temperature range	-55 to 150	

Notes:

⁽¹⁾Limited by package.

 $\ensuremath{^{(2)}}\ensuremath{\mathsf{Pulse}}$ limited by safe operating area.

 $^{(3)}$ Isp ≤ 7.5 A, di/dt ≤ 400 A/µs; Vps peak < V(BR)pss, Vpp = 400 V

 $^{(4)}$ V_{DS} \leq 480 V.

 $^{(5)}t = 1 \text{ s; } T_{C} = 25 \text{ °C.}$

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj} -case	Thermal resistance junction-case	5	°C/W
R _{thj} -amb	Thermal resistance junction-ambient	62.5 °C	

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
lar ⁽¹⁾	Avalanche current, repetitive or not repetitive	1.5	А
Eas ⁽²⁾	Single pulse avalanche energy	110	mJ

Notes:

 $^{\left(1\right) }$ Pulse width limited by $T_{jmax}.$

⁽²⁾ Starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	600			V
	Zara gata valtaga drain	$V_{GS} = 0 V, V_{DS} = 600 V$			1	
IDSS	IDSS Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_{case} = 125 \text{ °C}^{(1)}$			100	μA
I _{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ±25 V			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		0.55	0.60	Ω

Notes:

 $\ensuremath{^{(1)}}\xspace$ Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	400	-	
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	22	-	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V	-	0.84	-	ы
Coss eq. ⁽¹⁾	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	83	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A		6.4	-	Ω
Qg	Total gate charge	$V_{DD} = 480 V, I_D = 7.5 A,$	-	13.5	-	
Q _{gs}	Gate-source charge	$V_{GS} = 0$ to 10 V (see Figure 15: "Test circuit for gate charge	-	2.1	-	nC
Q _{gd}	Gate-drain charge	behavior")	-	7.2	-	

Table 6: Dynamic

Notes:

 $^{(1)}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDss.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 3.75 \text{ A}$	-	8.8	-	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Test circuit for	-	8	-	
$t_{d(off)}$	Turn-off delay time	resistive load switching times"	-	32.5	-	ns
tſ	Fall time	and Figure 19: "Switching time waveform")	-	13.2	-	

Table 7: Switching times



Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾	Source-drain current		-		7.5	А
I _{SDM} ⁽²⁾	Source-drain current (pulsed)		-		30	А
Vsd ⁽³⁾	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 7.5 A$	-		1.6	V
trr	Reverse recovery time	I _{SD} = 7.5 A, di/dt = 100 A/µs,	-	270		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for inductive load	-	2		μC
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	14.4		A
trr	Reverse recovery time	I _{SD} = 7.5 A, di/dt = 100 A/µs,	-	376		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	2.8		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	15		A

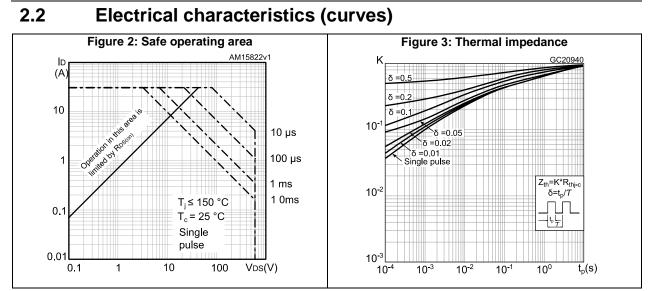
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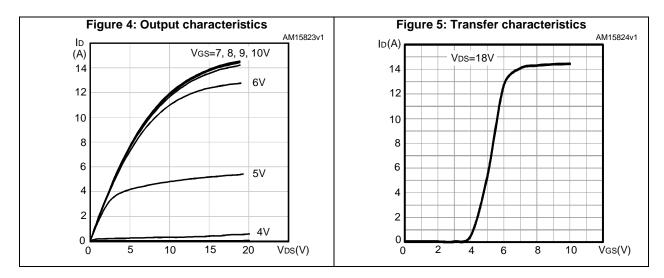
⁽¹⁾ Limited by package.

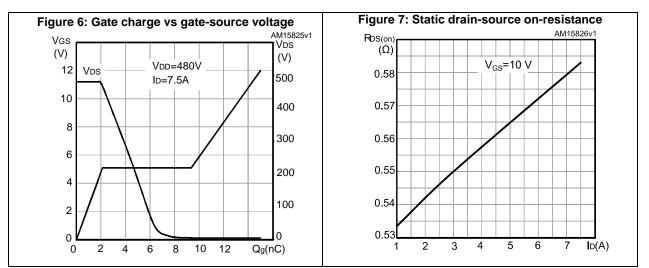
⁽²⁾ Pulse width is limited by safe operating area.

 $^{(3)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.





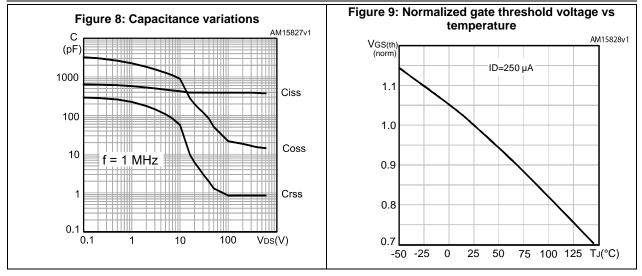


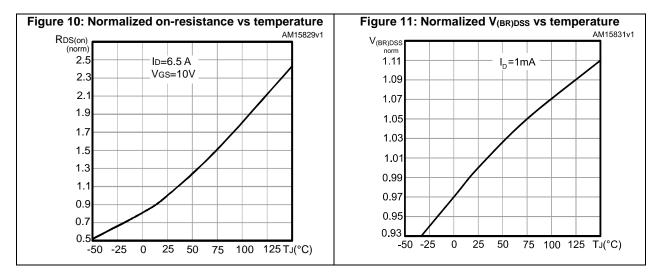


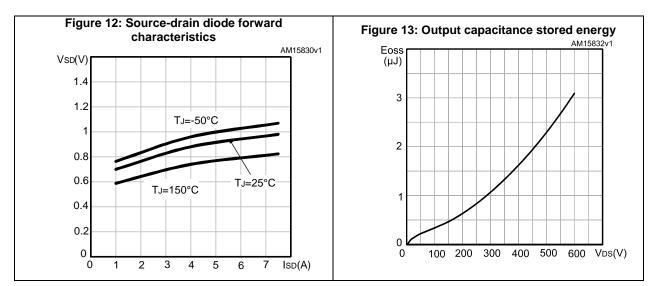


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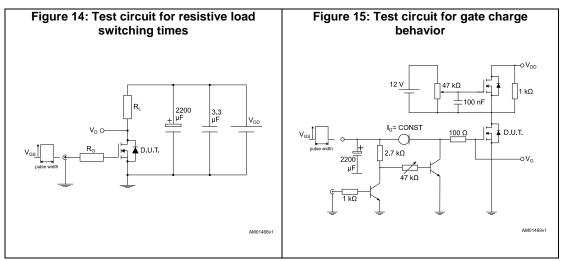
Electrical characteristics

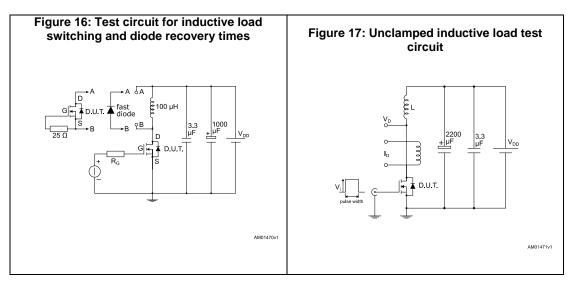


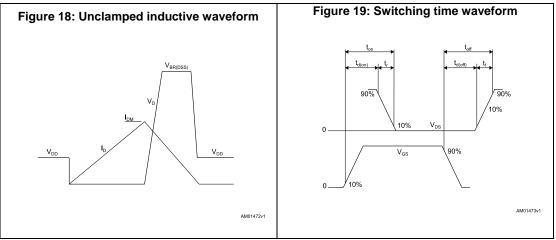




3 Test circuits







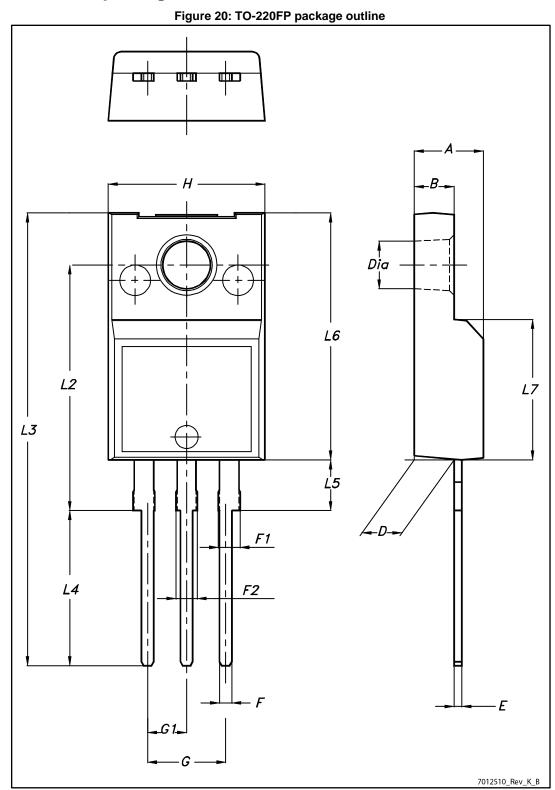


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.









Package information

	Table 9: TO-220FP pac	kage mechanical data	
Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2



5 Revision history

Table 10: Document revision history

Date	Revision	Changes
29-May-2013	1	First release.
14-Oct-2013	2	Modified: R _G value in <i>Table 6</i> Minor text changes
06-Dec-2013	3	Added: I ² PAKFP package – Modified: title – Modified: R _{DS(on)} typical values in <i>Table 5</i> – Modified: R _G value in <i>Table 6</i> – Modified: <i>Figure 7</i> and I _D value in <i>Figure 10</i> – Added: <i>Table 10</i> , and <i>Figure 21</i> – Minor text changes
09-Mar-2017	4	The device in I ² PAKFP has been removed and this document has been updated accordingly. Updated the title and the description in cover page. Updated <i>Table 4: "Avalanche characteristics"</i> . Minor text changes.



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